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PDF Solutions Investor Presentation

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PDF Solutions: Enabling the Digital Transformation of Semiconductor Manufacturing

We generate and integrate data across the supply chain, and using AI we drive fast improvements in yield, quality, and efficiency.



3 challenges the semiconductor industry must tackle

AI related devices will represent 70% of total semiconductor revenue in 2030*



innovations in 3D



operating through a complex global supply chain



leveraging AI at all levels, from design to manufacturing

*Source: IBS report on AI Nov 2024; **Source: SEMI report



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computers

airplanes



data centers







appliances

smartphones





Chips make the modern world possible.



How can the industry address these challenges?



innovations in 3D



operating through a complex global supply chain



leveraging AI at all levels, from design to manufacturing

Data, Analytics, & Actions enabled on a common platform

PDF/SOLUTIONS™ Strategy Overview





"the move to 3D chip packaging for higher density and faster signal transfer—requiring **new tools to predict and solve yield issues**"



"geopolitical shifts are decentralizing manufacturing via the US, Euro, Japan, and India Chips Acts—making remote collaboration crucial"

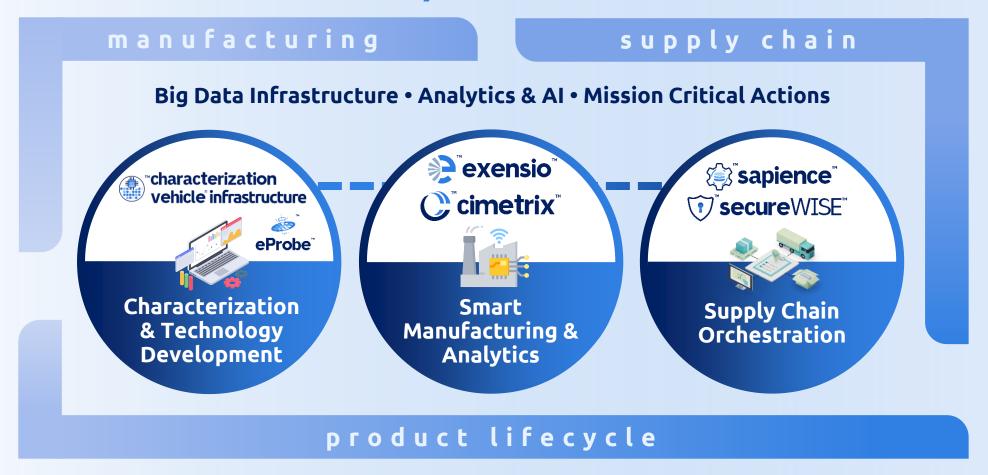


"with talent shortages, **AI must** augment human decision-making"

"Our software sits at the intersection of these trends—built on a common platform and database to help customers advance, collaborate, and scale AI without friction to drive operational efficiency."

The leading commercial data, analytics, and mission critical platform providing solutions in three key areas for the semiconductor ecosystem

PDF / SOLUTIONS°



PDF Solutions Differentiation

Data, Analytics, & Mission Critical platform, integrated with enterprise applications, enabling key business processes & cross-company collaboration



Industry and Domain Expertise



Create, Integrate, Align, Analyze, and Act on Data



Fully Integrated Solution Architecture



Cross Industry
Collaboration and
Execution

The Scale of the PDF Solutions Platform

The PDF Solutions platform connects the overall semiconductor ecosystem

from

DATA

2.5 PB

of cloud-managed data

20M

weekly data logs processed

895

semiconductor tapeouts

25k

analysis templates in use

ECOSYSTEM REACH

10s of Ks

100+ equipment OEMs

at >230 fabs connected

transmitting

PBs

of data between fabs, OSATs, fabless and OEMS

millions

of control parameters executed every day

across

55k 300mm fab tools connected for FDC

20+

OSATs connected

top 6 foundries

30% of top fabless

IT INFRASTRUCTURE

99.9%

uptime across all 8 regions

24/7 global

support

enabled on **all** major cloud providers

1.2k

Cassandra & Spark nodes

SOC 2

and

27001:2022 certified

Our Partners - Based on Industry Standards & Used Together with Leading Solutions Providers

SIEMENS

Design: E2E manufacturing data integration with test pattern layout & design

Collaboration with pT agents: monitors integrated for rapid diagnosis of chip product health

proteanTecs

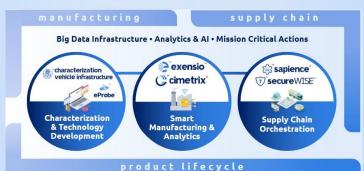


Assembly: Differentiated data & enhanced solutions

Financial: Links business & supply chain data with E2E manufacturing data for automation/analysis of quality & cost



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Semiconductor **industrystandard** organizations





MES: Integrated offering with PDF analytics

Test: AI solutions and test operations





Cloud platform: analytics partner for semiconductor supply chain solutions – over 78 products cloud ready.

Security: network, applications & edge server security

F#RTINET.

Trusted by the Top Companies in the Industry

Qualcom

"Exensio links together the huge variety of data types necessary to perform analysis across the value chain"

- Dan Rubens (Manager, IT)

intel

"PDFS integrates data [...] and provides templates to standardize, streamline, and automate data access and analysis..."

- Aziz Safa (Corporate VP)



"PDF Solutions: a partner **Committed**, **Experienced**, and **trusted** in the industry"

- Michael O'Sullivan (VP)

RENESAS

"Exensio GA is rolled out to ~96% of production volume and more than ~2000 products loaded to PDF cloud database"

- Helen Yu (VP)



"The benefits of test cell automation with PDF Solutions include **OEE Improvement**, large **labor saving**, and **ECC reduction**"

- Massimo Longaretti (Manager)



"Without Remote Tool Operations we would have ground to a halt (during COVID)"

- Randy Bakken (Engineer)

Working across the entire semiconductor ecosystem























JABIL

₹ ASE

Celestica[®]





am

JCET

KYEC







Qualcomm





公TDK

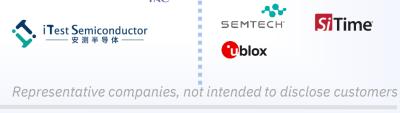














ACCRETECH

onto

As the Industry Evolves, Our Platform Expands through Acquisitions and R&D Investment

PDF Solutions Revenue

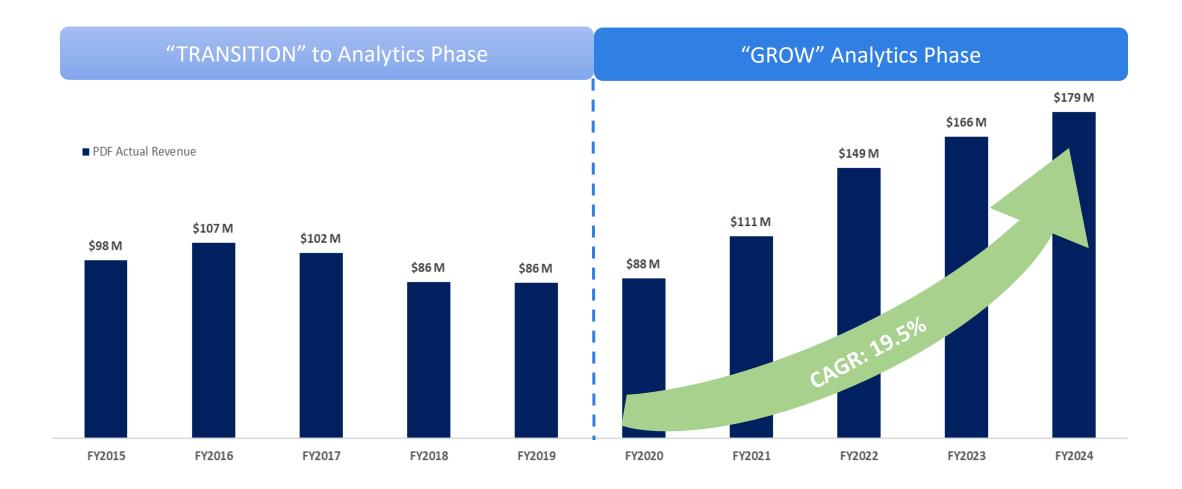


Continued Transition To Subscription Model

Overview of Revenue Sources

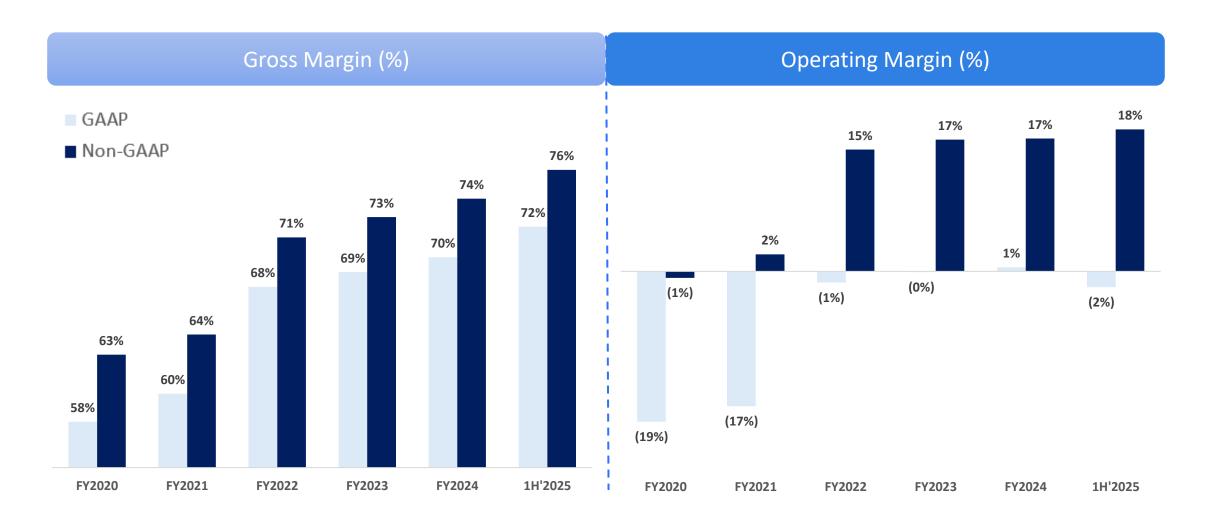
Revenue Categories	Revenue Source	Description	Туре
Analytics	Exensio Analytics	Big Data Analytics Platform	SaaS (cloud)
			Time-Based License Software and Hardware (on premise)
			Perpetual License Software (on premise)
	Differentiated Data	IP-based inline and end of line yield metrology solutions (DFI / CV)	Service and Time-Based License Software & Hardware (or capex for eProbe hardware)
	Cimetrix Connectivity	Equipment Communications & Interface Protocols	Perpetual License Software
	secureWISE	Secure Remote Access and Data Exchange Platform	SaaS
Integrated Yield Ramp	Fixed Fee	Software, IP and Service	Service and Time-Based License Software & Hardware
	Variable Fee / Gainshare		Performance-based Royalty Payment

Annual revenue trend from FY2015 to FY2024



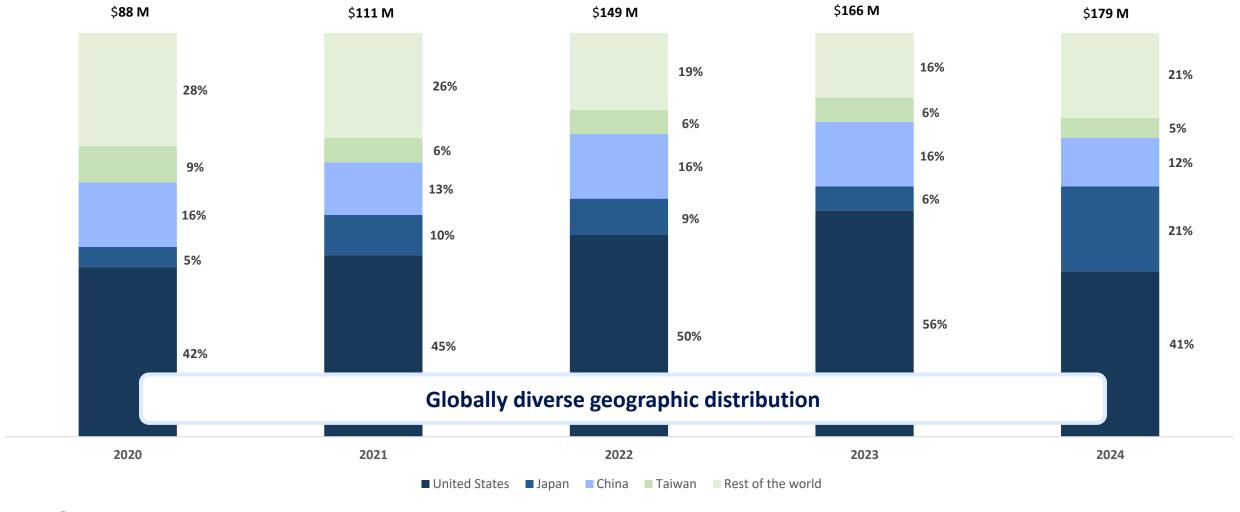


Annual and 1H'2025 gross margin and operating margin trend



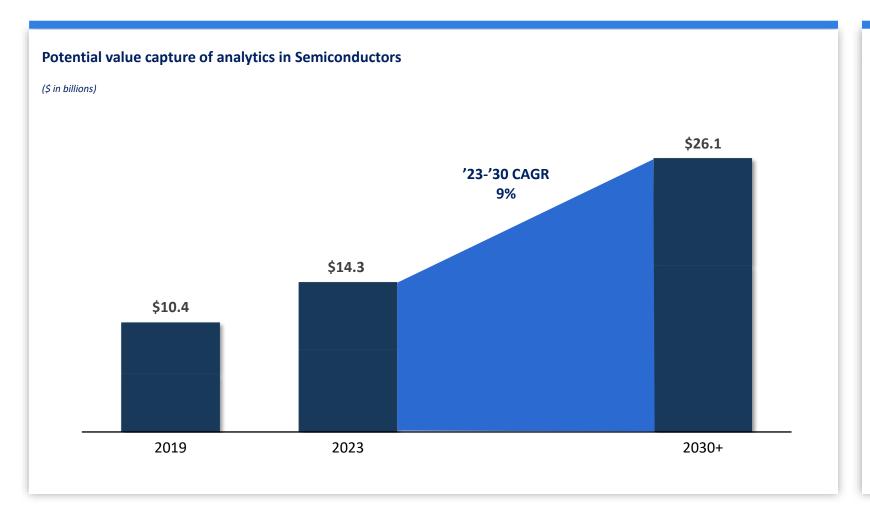


Global Geographic Revenue Distribution





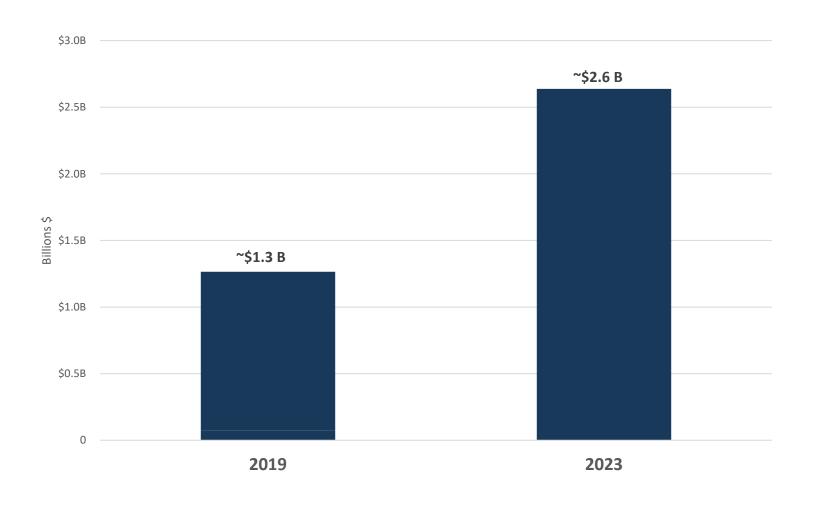
Total semiconductor analytics TAM



Methodology

- Analytics as a portion of total R&D and COGS spending by Semiconductor Companies across three categories:
 - Fabless-Logic
 - IDM
 - Memory/Storage
- Estimated % of spending attributable to analytics based on each company type – Fabless-Logic, IDM, Memory/Storage
- Based on FactSet consensus spending estimates for 2023 for individual companies and industry experts projecting a \$1T market for semiconductor revenue by 2030+

Market opportunity – PDF SAM

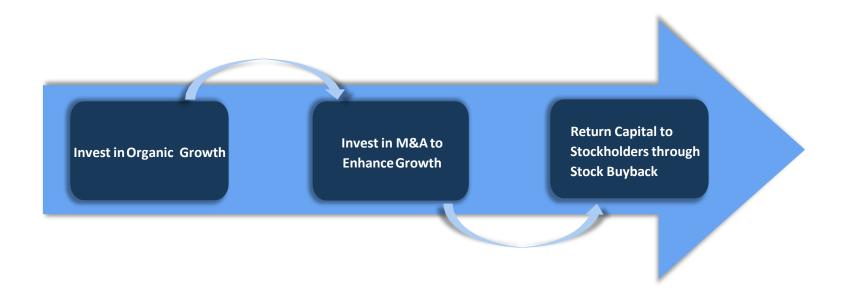


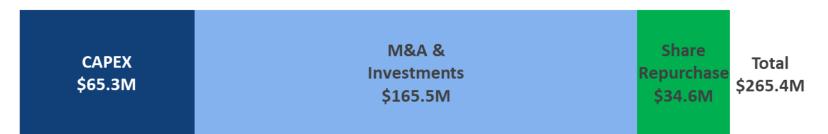
- SAM of more than \$2B (based on 2023 data)
- Growth drivers:
 - Adoption across supply chain
 - AI & advanced solutions
 - DFI/eProbe for quality & reliability
 - Cloud and data growth

Source: PDF Solutions estimates



Disciplined Capital Allocation





2020 to Q2'25

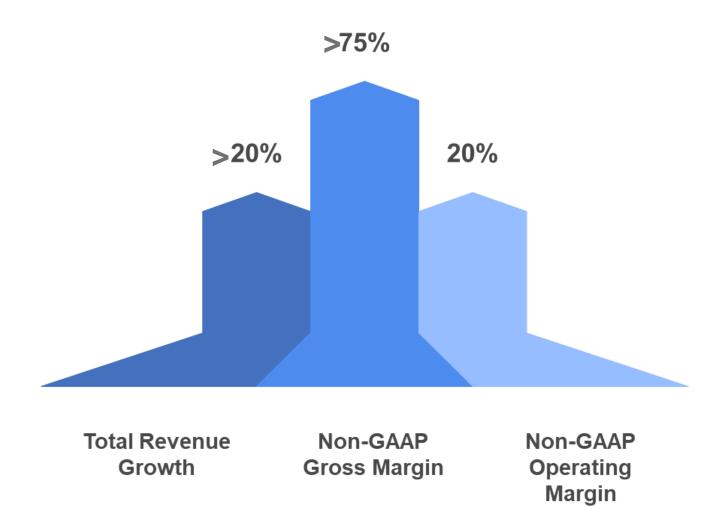
Latest Balance Sheet

Q2 2025 cash: **\$40.4M**

Q2 2025 debt: **\$68.1M**



Long-term Target Financial Model



from 2023 Analysts Day

Q2 2025 Results Summary



Thank You PDF/solutions

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